

Taiwan Semiconductor Research Institute, National Applied Research Laboratories

2025 Chip Tape-out Schedule

Updated on: Mar. 19, 2025

I. Description of process codes, processes, and annual MPW schedule for each process:

Note: The MPW schedule for each process is indicated as the “process code” - year + (A/B/C/D/E). For example, D35-114A represents MPW Run A for the D35 process in 2025.

Process code	Process description	Number of MPW runs in first half of the year	Number of MPW runs in second half of the year
TN7	TSMC 7nm CMOS LOGIC Fin FET ELK Cu 1P15M 0.75/1.8V	1	1
TN16FFC	TSMC 16 nm CMOS LOGIC FinFET Compact (Shrink) LL ELK Cu 1P13M 0.8&1.8V	1	2
TN28HPCplu	TSMC 28 nm CMOS RF High Performance Compact Mobile Computing Plus (HPC+) ELK Cu 1P10M 0.9&1.8V	2	2
TN40G	TSMC 45 nm CMOS LOGIC General Purpose Superb (40G) ELK Cu 1P10M 0.9/2.5V	2	1
TN65GP	TSMC 65 nm CMOS Mixed Signal RF General Purpose Plus LowK Cu 1P9M 1.0&2.5V	1	2
TN90GUTM	TSMC 90 nm CMOS Mixed Signal MS General Purpose Standard Process LowK Cu 1P9M 1.0&3.3V (With UTM)	1	1
SiGe18	TSMC 0.18 um BICMOS Mixed Signal SiGe General Purpose Standard Process FSG Al 3P6M 1.8&3.3V	1	1
T18HVG2	TSMC 0.18UM CMOS HIGH VOLTAGE MIXED SIGNAL BASED GENERATION II BCD 1P6M SALICIDE AL_FSG 1.8/5/6/7/8/12/16/20/24/29/36/45/55/65/70V/VG 1.8/5V AND 5/6/7/8/12/16/20/24/29/36/45/55/65/70V/VG5V	1	2
T18	TSMC 0.18 um CMOS Mixed Signal RF General Purpose Standard Process FSG Al 1P6M 1.8&3.3V	2	2
U18	UMC 0.18 um Mixed-Mode and RFCMOS 1.8V/3.3V 1P6M Metal Metal Capacitor Process	1	2
U18MEMS	UMC 0.18um CMOS and MEMS Process	1	2
D35	TSMC 0.35 um Mixed-Signal 2P4M Polycide 3.3/5V	2	1
Multi-Option-MEMS	TSMC 0.35um CMOS Process and APM MEMS Process wi/wo Gold	2	1
T50GaN	TSMC 0.50 UM DISCRETE DEVICE GAN WBG USG AL0P3M HKMG 650V	1	1
GaN12	WIN 0.12um RF GaN on SiC Technology	1	2
P15	WIN 0.15 um PHEMT	1	0
IMEC-SiPh	200mm wafer, 0.13um mask technology, 220nm Si SOI, imec’s silicon photonics	0	1

II. Description of important matters:

- (1) Due to TSMC's reduction in the number of shuttle runs for the TN40G and TN90GUTM in 114, TSRI has introduced the TN65GP process to enhance the breadth and iterations of academic research.
- (2) Since TSMC has adjusted the operation method for shuttles, from fiscal year 114 onward, applicants for processes utilizing shuttle methods, including TN7, TN16FFC, TN28HPCplu, TN40G, TN65GP, TN90GUTM, SiGe18, and T18HVG2, must submit their chip production applications early. Additionally, applicants are required to upload the first version of the GDS file before the application deadline. This initial GDS version does not need to be a complete layout or DRC-clean, but the layout area should closely match that of the final version. Each iteration's coordinator will collect area information from all applications after the submission deadline and will then enable file uploads for each application. Applicants should upload their production-ready, DRC-clean GDS files along with electronic files for DRC, LVS, design content, and

relevant TRF files before the deadlines for forward-looking/educational file uploads (by 14:00 on the specified day) and Quick Review / full-price Chip file uploads. Please note that after the application deadline, do not arbitrarily cancel applications. The GDS file uploaded by the file upload deadline should have a layout area identical to that of the first version submitted, and any differences in area should not be significant to avoid inaccuracies in area demand estimations for that iteration, which could lead to operational issues later on.

- (3) **Educational chip tape-out arrangement:** The TSRI's educational chip implementation service for each MPW run will arrange one to three chips for tape-out per round for each "course." To maximize resource utilization, the second, third, or more rounds of tape-out scheduling are also provided to courses with more student applications until the usable area for the current MPW run is depleted or all educational chips have been scheduled for tape-out. **"There is no tape-out chip limit for each course,"** and arrangements will be made based on the usable area for each MPW run. It is hoped that the majority of students will receive complete training on chip design and measurement.
- (4) **Description of chip tape-out schedule for the U18 and U18MEMS processes:** The U18 and U18MEMS processes have adjusted the chip-out schedule according to recent operational timelines. Additionally, the prescheduled MPW run schedules for U18-114A and U18MEMS have also been adjusted. Please refer to the latest schedule provided for details.
- (5) In addition to the shuttle time of foundries, this schedule has been established with the graduation time for schools' master's degree programs and the submission deadlines of international seminars taken into account. Any adjustment to the schedule will be announced in the Latest News section on the TSRI website.
- (6) CMOS MEMS chips are included in the TSMC 0.35um and UMC 0.18um COMS processes (such as Multi-Option-MEMS-114A and U18MEMS-114A MPW runs). For CMOS MEMS chips, wafers must undergo post-process treatment which takes about four weeks.

III. Description of process and MPW run changes:

- (1) Please note that, in line with the actual shuttle schedule of foundries, the scheduled MPW runs for 2025 are changed as follows, and the rescheduled runs are also marked in the original schedule.
 - The application open date for the TN7-114A MPW run is changed to 2024.11.04, and the application deadline is changed to 2024.11.11.
 - The application open date for the TN16FFC-114A MPW run is changed to 2025.02.10, and the application deadline is changed to 2025.02.17.
 - The application open date for the TN28HPC+-114A MPW run is changed to 2025.01.13, and the application deadline is changed to 2025.01.20.
 - The application open date for the TN40G-114A MPW run is changed to 2025.01.06, and the application deadline is changed to 2025.01.13.
 - The application open date for the TN90GUTM-114A MPW run is changed to 2025.04.21, and the application deadline is changed to 2025.04.28.
 - The application open date for the SiGe18-114A MPW run is changed to 2024.12.09, and the application deadline is changed to 2024.12.16.
 - The application open date for the T18HVG2-114A MPW run is changed to 2025.01.13, and the application deadline is changed to 2025.01.20.
 - The application open date for the T18-114A MPW run is changed to 2025.02.17, and the application deadline is changed to 2025.02.24.
 - The application open date for the T50GaN-114A MPW run is changed to 2025.03.17, and the application deadline is changed to 2025.03.24.
 - The application open date for the TN7-114B MPW run is changed to 2025.06.23, and the application deadline is changed to 2025.06.30.
 - The application open date for the GaN12-114B MPW run is changed to 2025.06.30, and the application deadline is changed to 2025.07.07.
 - Deadline for uploading files for Advanced Chip for the TN28HPC+-114C MPW run is changed to 2025.08.11, and Review Meeting is changed to 2025.08.23.

- (2) **2025 Chip Tape-out Schedule for the IMEC-SiPh-114A has been announced. Please refer to the latest schedule provided for details.**

IV. Explanation of the commonly used names of the chip manufacturing schedule:

- (1) Open application: the open application day for the **manufacturing of advanced, educational, advanced quick review of partial-funding and academic full-price** chips; the application is open **at 10:00 am** on the same day. There is a total of 8 calendar days from the open application day to the deadline for educational chip/ advance chip application; a total of 15 calendar days from the open application day to the deadline for **advanced** quick review partial-**funding** chip/ academic full-price chip application.

[The time for users to apply online for chip manufacturing application of each process session is from the open application to the application deadline, and the rest of the time is NOT open for any chip production application.]

- (2) **Educational Chip Deadline: The deadline for educational chip application is 14:00 on the same day.**
- (3) **Advanced Chip Deadline: The deadline is 14:00 on the same day.**
- (4) **Deadline for uploading files for Advanced Chip/Educational Chip applications: The deadline for uploading files related to Advanced Chip and Educational Chip applications is 14:00 on the specified afternoon.**
- (5) **Deadline for Advanced Quick Review Chip Application: The date of the deadline for the application of prospective quick review of partial-funding Chip.**
- (6) **Deadline for Academic full-price Chip Application: The date of the deadline for the application of Academic full-price Chip.**
- (7) **Deadline for uploading files for Advanced Quick Review / Academic full-price Chip: The deadline for uploading files related to Advanced Quick Review chips and Academic full-price Chip applications.**
- (8) **Review Meeting: the date when Advanced Chip participates in the review meeting.**
- (9) **Deadline for the First Stage of Approval: The deadline for the professor to sign on the TSRI website to agree to the chip manufacturing application submitted by the student or the professor himself/herself.**

[If the chip manufacturing application fails to obtain the professor's signature and approval before the deadline for the first stage of approval, the chip manufacturing application is to be cancelled.]

- (10) **Chip Out: Estimated Chip Shipment Date**

[The Chip Out Date in the announcement is the estimated chip shipment date. The actual chip shipment date depends on the actual transaction situation with the fabrication plant/package factory/assembly house. Please excuse us that our center does NOT need to bear the penalty for overdue delivery.]

- (11) **Deadline for Submitting the Test Report: After receiving the chip, the deadline for submitting the report of the measurement results.**

2025 Chip Tape-out Schedule (listed by process type)

★Deadline for uploading files for Advanced Chip, Educational Chip, Advanced Quick Review Chip and Academic full-price Chip have been added to this schedule.

MPW run	Open application	Educational Chip Deadline	Advanced Chip Deadline	Deadline for uploading files for Advanced Chip/ Educational Chip applications	Deadline for Advanced Quick Review Chip Application	Deadline for Academic full-price Chip Application	Deadline for uploading files for Advanced Quick Review / Academic full-price Chip	Review Meeting	Deadline for the First Stage of Approval	Chip Out	Deadline for Submitting the Test Report
TN7-114A	2024.11.04	X	2024.11.11	2024.12.09	X	2024.11.11	2024.12.16	2024.12.21	2024.12.25	2025.06.02	2025.08.06
TN7-114B	2025.06.23	X	2025.06.30	2025.07.28	X	2025.06.30	2025.08.04	2025.08.09	2025.08.13	2026.01.19	2026.03.25
TN16FFC-114A	2025.02.10	X	2025.02.17	2025.03.17	X	2025.02.17	2025.03.24	2025.03.29	2025.04.02	2025.08.03	2025.10.07
TN16FFC-114B	2025.06.02	X	2025.06.09	2025.07.07	X	2025.06.09	2025.07.14	2025.07.19	2025.07.23	2025.11.23	2026.01.27
TN16FFC-114C	2025.10.06	X	2025.10.13	2025.11.10	X	2025.10.13	2025.11.17	2025.11.22	2025.11.26	2026.03.29	2026.06.02
TN28HPC+-114A	2025.01.13	X	2025.01.20	2025.02.24	X	2025.01.20	2025.03.03	2025.03.08	2025.03.12	2025.07.09	2025.09.12
TN28HPC+-114B	2025.04.07	X	2025.04.14	2025.05.12	X	2025.04.14	2025.05.19	2025.05.24	2025.05.28	2025.09.24	2025.11.28
TN28HPC+-114C	2025.07.14	X	2025.07.21	2025.08.11	X	2025.07.21	2025.08.18	2025.08.23	2025.08.27	2025.12.31	2026.03.06
TN28HPC+-114D	2025.10.06	X	2025.10.13	2025.11.10	X	2025.10.13	2025.11.17	2025.11.22	2025.11.26	2026.03.25	2026.05.29
TN40G-114A	2025.01.06	X	2025.01.13	2025.02.10	X	2025.01.13	2025.02.17	2025.02.22	2025.02.26	2025.06.26	2025.08.30
TN40G-114B	2025.03.03	X	2025.03.10	2025.04.07	X	2025.03.10	2025.04.14	2025.04.19	2025.04.23	2025.08.14	2025.10.18
TN40G-114C	2025.07.07	X	2025.07.14	2025.08.11	X	2025.07.14	2025.08.18	2025.08.23	2025.08.27	2025.12.18	2026.02.21
TN65GP-114A	2025.02.10	2025.02.17	2025.02.17	2025.03.17	X	2025.02.17	2025.03.24	2025.03.29	2025.04.02	2025.07.20	2025.09.23
TN65GP-114B	2025.05.05	2025.05.12	2025.05.12	2025.06.09	X	2025.05.12	2025.06.16	2025.06.21	2025.06.25	2025.10.12	2025.12.16
TN65GP-114C	2025.09.01	2025.09.08	2025.09.08	2025.10.06	X	2025.09.08	2025.10.13	2025.10.18	2025.10.22	2026.02.08	2026.04.14
TN90GUTM-114A	2025.04.21	2025.04.28	2025.04.28	2025.05.26	X	2025.04.28	2025.06.02	2025.06.07	2025.06.11	2025.09.28	2025.12.02
TN90GUTM-114B	2025.10.20	2025.10.27	2025.10.27	2025.11.24	X	2025.10.27	2025.12.01	2025.12.06	2025.12.10	2026.03.29	2026.06.02
SiGe18-114A	2024.12.09	2024.12.16	2024.12.16	2025.01.13	X	2024.12.16	2025.01.20	X	2025.02.05	2025.05.30	2025.08.03
SiGe18-114B	2025.08.11	2025.08.18	2025.08.18	2025.09.15	X	2025.08.18	2025.09.22	X	2025.10.01	2026.01.23	2026.03.29
T18HVG2-114A	2025.01.13	2025.01.20	2025.01.20	2025.02.17	2025.01.20	2025.01.20	2025.02.24	X	2025.03.05	2025.07.02	2025.09.05
T18HVG2-114B	2025.05.05	2025.05.12	2025.05.12	2025.06.09	2025.05.12	2025.05.12	2025.06.16	X	2025.06.25	2025.10.22	2025.12.26
T18HVG2-114C	2025.09.01	2025.09.08	2025.09.08	2025.10.06	2025.09.08	2025.09.08	2025.10.13	X	2025.10.22	2026.02.18	2026.04.24
T18-114A	2025.02.17	2025.02.24	2025.02.24	2025.02.24	2025.03.03	2025.03.03	2025.03.03	X	2025.03.12	2025.06.20	2025.08.24
T18-114B	2025.05.12	2025.05.19	2025.05.19	2025.05.19	2025.05.26	2025.05.26	2025.05.26	X	2025.06.04	2025.09.12	2025.11.16
T18-114C	2025.08.18	2025.08.25	2025.08.25	2025.08.25	2025.09.01	2025.09.01	2025.09.01	X	2025.09.10	2025.12.19	2026.02.22
T18-114D	2025.11.03	2025.11.10	2025.11.10	2025.11.10	2025.11.17	2025.11.17	2025.11.17	X	2025.11.26	2026.03.06	2026.05.10
U18-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.06.12	2025.08.16
U18-114B	2025.06.16	2025.06.23	2025.06.23	2025.06.23	2025.06.30	2025.06.30	2025.06.30	X	2025.07.09	2025.11.13	2026.01.17
U18-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	2025.11.03	2025.11.03	2025.11.03	X	2025.11.12	2026.03.19	2026.05.23
U18MEMS-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.07.27	2025.09.30
U18MEMS-114B	2025.06.16	2025.06.23	2025.06.23	2025.06.23	2025.06.30	2025.06.30	2025.06.30	X	2025.07.09	2025.12.28	2026.03.03
U18MEMS-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	2025.11.03	2025.11.03	2025.11.03	X	2025.11.12	2026.05.03	2026.07.07
D35-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.05.06	2025.07.10
D35-114B	2025.04.28	2025.05.05	2025.05.05	2025.05.05	2025.05.12	2025.05.12	2025.05.12	X	2025.05.21	2025.08.19	2025.10.23
D35-114C	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2025.12.30	2026.03.05
MultioptionMEMS-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.08.16	2025.10.20
MultioptionMEMS-114B	2025.04.28	2025.05.05	2025.05.05	2025.05.05	2025.05.12	2025.05.12	2025.05.12	X	2025.05.21	2025.11.29	2026.02.02
MultioptionMEMS-114C	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2026.04.11	2026.06.15
T50GaN-114A	2025.03.17	2025.03.24	2025.03.24	2025.03.24	2025.03.31	2025.03.31	2025.03.31	X	2025.04.09	2025.08.22	2025.10.26
T50GaN-114B	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2026.02.13	2026.04.19
GaN12-114A	2025.02.17	2025.02.24	2025.02.24	2025.02.24	X	2025.03.03	2025.03.03	X	2025.03.12	2025.07.26	2025.09.29
GaN12-114B	2025.06.30	2025.07.07	2025.07.07	2025.07.07	X	2025.07.14	2025.07.14	X	2025.07.23	2025.12.06	2026.02.09
GaN12-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	X	2025.11.03	2025.11.03	X	2025.11.12	2026.03.28	2026.06.01
P15-114A	2025.05.19	2025.05.26	2025.05.26	2025.05.26	X	2025.06.02	2025.06.02	X	2025.06.11	2025.09.12	2025.11.16
IMEC-SiPh-114A	2025.08.11	X	2025.08.18	2025.08.18	X	2025.08.25	2025.08.25	X	2025.09.03	2027.02.26	2027.05.02

2025 Chip Tape-out Schedule (listed by application deadline)

★Deadline for uploading files for Advanced Chip, Educational Chip, Advanced Quick Review Chip and Academic full-price Chip have been added to this schedule.

MPW run	Open application	Educational Chip Deadline	Advanced Chip Deadline	Deadline for uploading files for Advanced Chip/ Educational Chip applications	Deadline for Advanced Quick Review Chip Application	Deadline for Academic full-price Chip Application	Deadline for uploading files for Advanced Quick Review / Academic full-price Chip	Review Meeting	Deadline for the First Stage of Approval	Chip Out	Deadline for Submitting the Test Report
TN7-114A	2024.11.04	X	2024.11.11	2024.12.09	X	2024.11.11	2024.12.16	2024.12.21	2024.12.25	2025.06.02	2025.08.06
SiGe18-114A	2024.12.09	2024.12.16	2024.12.16	2025.01.13	X	2024.12.16	2025.01.20	X	2025.02.05	2025.05.30	2025.08.03
TN40G-114A	2025.01.06	X	2025.01.13	2025.02.10	X	2025.01.13	2025.02.17	2025.02.22	2025.02.26	2025.06.26	2025.08.30
U18-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.06.12	2025.08.16
U18MEMS-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.07.27	2025.09.30
D35-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.05.06	2025.07.10
MultioptionMEMS-114A	2025.01.06	2025.01.13	2025.01.13	2025.01.13	2025.01.20	2025.01.20	2025.01.20	X	2025.02.05	2025.08.16	2025.10.20
TN28HPC+-114A	2025.01.13	X	2025.01.20	2025.02.24	X	2025.01.20	2025.03.03	2025.03.08	2025.03.12	2025.07.09	2025.09.12
T18HVG2-114A	2025.01.13	2025.01.20	2025.01.20	2025.02.17	2025.01.20	2025.01.20	2025.02.24	X	2025.03.05	2025.07.02	2025.09.05
TN16FFC-114A	2025.02.10	X	2025.02.17	2025.03.17	X	2025.02.17	2025.03.24	2025.03.29	2025.04.02	2025.08.03	2025.10.07
TN65GP-114A	2025.02.10	2025.02.17	2025.02.17	2025.03.17	X	2025.02.17	2025.03.24	2025.03.29	2025.04.02	2025.07.20	2025.09.23
T18-114A	2025.02.17	2025.02.24	2025.02.24	2025.02.24	2025.03.03	2025.03.03	2025.03.03	X	2025.03.12	2025.06.20	2025.08.24
GaN12-114A	2025.02.17	2025.02.24	2025.02.24	2025.02.24	X	2025.03.03	2025.03.03	X	2025.03.12	2025.07.26	2025.09.29
TN40G-114B	2025.03.03	X	2025.03.10	2025.04.07	X	2025.03.10	2025.04.14	2025.04.19	2025.04.23	2025.08.14	2025.10.18
T50GaN-114A	2025.03.17	2025.03.24	2025.03.24	2025.03.24	2025.03.31	2025.03.31	2025.03.31	X	2025.04.09	2025.08.22	2025.10.26
TN28HPC+-114B	2025.04.07	X	2025.04.14	2025.05.12	X	2025.04.14	2025.05.19	2025.05.24	2025.05.28	2025.09.24	2025.11.28
TN90GUTM-114A	2025.04.21	2025.04.28	2025.04.28	2025.05.26	X	2025.04.28	2025.06.02	2025.06.07	2025.06.11	2025.09.28	2025.12.02
D35-114B	2025.04.28	2025.05.05	2025.05.05	2025.05.05	2025.05.12	2025.05.12	2025.05.12	X	2025.05.21	2025.08.19	2025.10.23
MultioptionMEMS-114B	2025.04.28	2025.05.05	2025.05.05	2025.05.05	2025.05.12	2025.05.12	2025.05.12	X	2025.05.21	2025.11.29	2026.02.02
TN65GP-114B	2025.05.05	2025.05.12	2025.05.12	2025.06.09	X	2025.05.12	2025.06.16	2025.06.21	2025.06.25	2025.10.12	2025.12.16
T18HVG2-114B	2025.05.05	2025.05.12	2025.05.12	2025.06.09	2025.05.12	2025.05.12	2025.06.16	X	2025.06.25	2025.10.22	2025.12.26
T18-114B	2025.05.12	2025.05.19	2025.05.19	2025.05.19	2025.05.26	2025.05.26	2025.05.26	X	2025.06.04	2025.09.12	2025.11.16
P15-114A	2025.05.19	2025.05.26	2025.05.26	2025.05.26	X	2025.06.02	2025.06.02	X	2025.06.11	2025.09.12	2025.11.16
TN16FFC-114B	2025.06.02	X	2025.06.09	2025.07.07	X	2025.06.09	2025.07.14	2025.07.19	2025.07.23	2025.11.23	2026.01.27
U18-114B	2025.06.16	2025.06.23	2025.06.23	2025.06.23	2025.06.30	2025.06.30	2025.06.30	X	2025.07.09	2025.11.13	2026.01.17
U18MEMS-114B	2025.06.16	2025.06.23	2025.06.23	2025.06.23	2025.06.30	2025.06.30	2025.06.30	X	2025.07.09	2025.12.28	2026.03.03
TN7-114B	2025.06.23	X	2025.06.30	2025.07.28	X	2025.06.30	2025.08.04	2025.08.09	2025.08.13	2026.01.19	2026.03.25
GaN12-114B	2025.06.30	2025.07.07	2025.07.07	2025.07.07	X	2025.07.14	2025.07.14	X	2025.07.23	2025.12.06	2026.02.09
TN40G-114C	2025.07.07	X	2025.07.14	2025.08.11	X	2025.07.14	2025.08.18	2025.08.23	2025.08.27	2025.12.18	2026.02.21
TN28HPC+-114C	2025.07.14	X	2025.07.21	2025.08.11	X	2025.07.21	2025.08.18	2025.08.23	2025.08.27	2025.12.31	2026.03.06
IMEC-SiPh-114A	2025.08.11	X	2025.08.18	2025.08.18	X	2025.08.25	2025.08.25	X	2025.09.03	2027.02.26	2027.05.02
SiGe18-114B	2025.08.11	2025.08.18	2025.08.18	2025.09.15	X	2025.08.18	2025.09.22	X	2025.10.01	2026.01.23	2026.03.29
T18-114C	2025.08.18	2025.08.25	2025.08.25	2025.08.25	2025.09.01	2025.09.01	2025.09.01	X	2025.09.10	2025.12.19	2026.02.22
TN65GP-114C	2025.09.01	2025.09.08	2025.09.08	2025.10.06	X	2025.09.08	2025.10.13	2025.10.18	2025.10.22	2026.02.08	2026.04.14
T18HVG2-114C	2025.09.01	2025.09.08	2025.09.08	2025.10.06	2025.09.08	2025.09.08	2025.10.13	X	2025.10.22	2026.02.18	2026.04.24
D35-114C	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2025.12.30	2026.03.05
MultioptionMEMS-114C	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2026.04.11	2026.06.15
T50GaN-114B	2025.09.08	2025.09.15	2025.09.15	2025.09.15	2025.09.22	2025.09.22	2025.09.22	X	2025.10.01	2026.02.13	2026.04.19
TN16FFC-114C	2025.10.06	X	2025.10.13	2025.11.10	X	2025.10.13	2025.11.17	2025.11.22	2025.11.26	2026.03.29	2026.06.02
TN28HPC+-114D	2025.10.06	X	2025.10.13	2025.11.10	X	2025.10.13	2025.11.17	2025.11.22	2025.11.26	2026.03.25	2026.05.29
TN90GUTM-114B	2025.10.20	2025.10.27	2025.10.27	2025.11.24	X	2025.10.27	2025.12.01	2025.12.06	2025.12.10	2026.03.29	2026.06.02
U18-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	2025.11.03	2025.11.03	2025.11.03	X	2025.11.12	2026.03.19	2026.05.23
U18MEMS-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	2025.11.03	2025.11.03	2025.11.03	X	2025.11.12	2026.05.03	2026.07.07
GaN12-114C	2025.10.20	2025.10.27	2025.10.27	2025.10.27	X	2025.11.03	2025.11.03	X	2025.11.12	2026.03.28	2026.06.01
T18-114D	2025.11.03	2025.11.10	2025.11.10	2025.11.10	2025.11.17	2025.11.17	2025.11.17	X	2025.11.26	2026.03.06	2026.05.10